



**NTE2921
MOSFET
N-Ch, Enhancement Mode
High Speed Switch**

Features:

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements

Absolute Maximum Ratings:

Continuous Drain Current ($V_{GS} = 10V$), I_D	
$T_C = +25^\circ C$	15A
$T_C = +100^\circ C$	9.7A
Pulsed Drain Current (Note 1), I_{DM}	60A
Power Dissipation ($T_C = +25^\circ C$), P_D	150W
Derate Linearly Above $25^\circ C$	1.2W/ $^\circ C$
Gate-to-Source Voltage, V_{GS}	± 20
Single Pulse Avalanche Energy (Note 2), E_{AS}	550mJ
Avalanche Current (Note 1), I_{AR}	15A
Repetitive Avalanche Energy (Note 1), E_{AR}	15mJ
Peak Diode Recovery dv/dt (Note 3), dv/dt	4.8V/ns
Operating Junction Temperature Range, T_J	-55° to +150° $^\circ C$
Storage Temperature Range, T_{stg}	-55° to +150° $^\circ C$
Lead Temperature (During Soldering, 1.6mm from case for 10sec), T_L	+300° $^\circ C$
Mounting Torque (6-32 or M3 Screw)	10 lbf•in (1.1N•m)
Thermal Resistance, Junction-to-Case, R_{thJC}	0.83° $^\circ C/W$
Thermal Resistance, Junction-to-Ambient, R_{thJA}	40° $^\circ C/W$
Typical Thermal Resistance, Case-to-Sink (Flat, Greased Surface), R_{thCS}	0.24° $^\circ C/W$

Note 1. Repetitive rating; pulse width limited by maximum junction temperature.

Note 2. $V_{DD} = 50V$, starting $T_J = +25^\circ C$, $L = 3.9mH$, $R_G = 25\Omega$, $I_{AS} = 15A$

Note 3. $I_{SD} \leq 15A$, $di/dt \leq 150A/\mu s$, $V_{DD} \leq 250V$, $T_J \leq +150^\circ C$

Note 4. Pulses Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.

Electrical Characteristics: ($T_J = +25^\circ\text{C}$ unless otherwise specified)

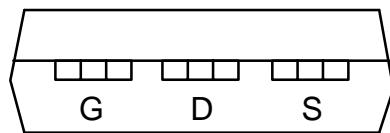
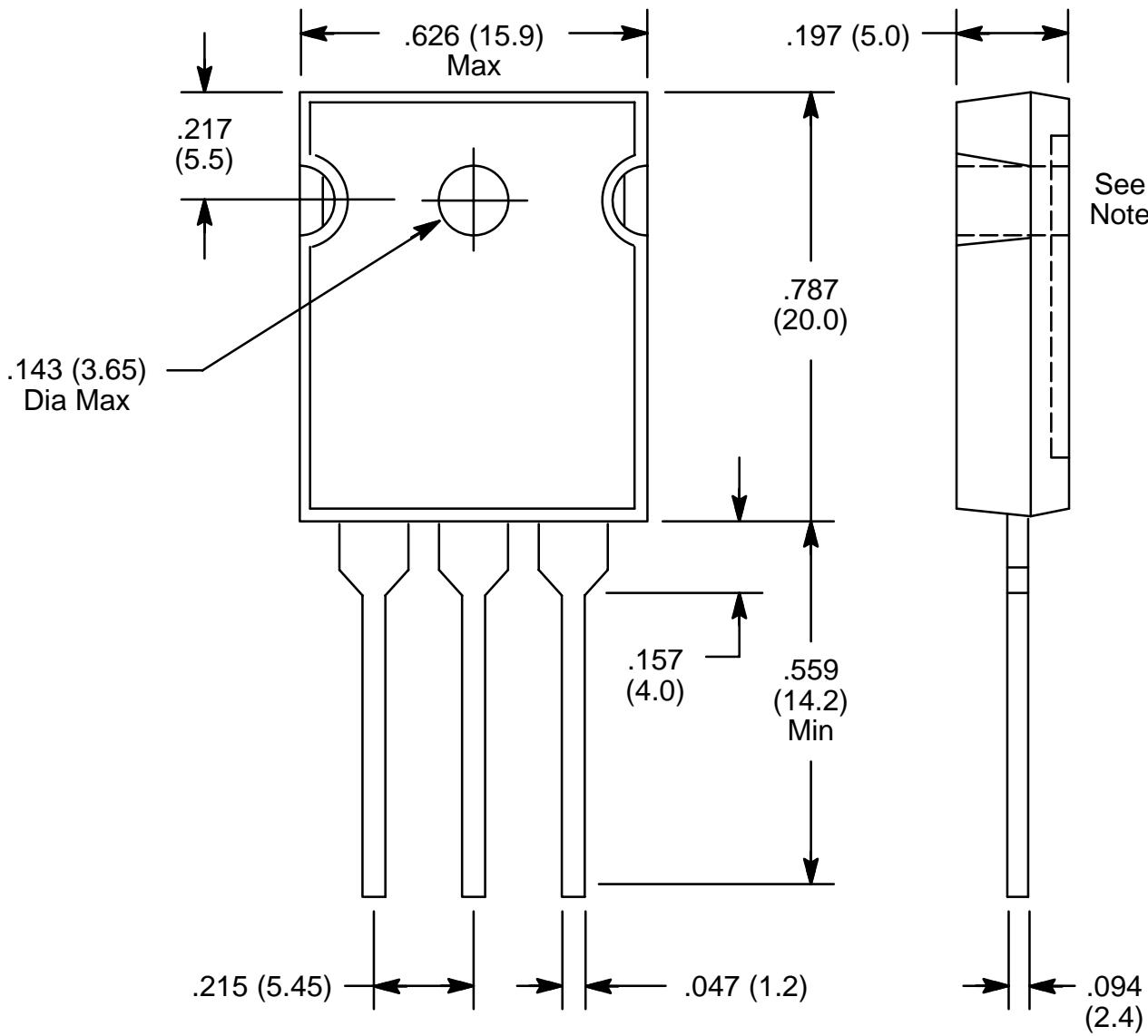
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-to-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	250	—	—	V
Breakdown Voltage Temp. Coefficient	$\frac{\Delta V_{(\text{BR})\text{DSS}}}{\Delta T_J}$	Reference to $+25^\circ\text{C}$, $I_D = 1\text{mA}$	—	0.37	—	$\text{V}/^\circ\text{C}$
Static Drain-to-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 9\text{A}$, Note 4	—	—	0.28	Ω
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	2.0	—	4.0	V
Forward Transconductance	g_{fs}	$V_{\text{DS}} = 50\text{V}, I_D = 9\text{A}$, Note 4	6.7	—	—	mhos
Drain-to-Source Leakage Current	I_{DSS}	$V_{\text{DS}} = 250\text{V}, V_{\text{GS}} = 0\text{V}$	—	—	25	μA
		$V_{\text{DS}} = 200\text{V}, V_{\text{GS}} = 0\text{V}, T_J = +125^\circ\text{C}$	—	—	250	μA
Gate-to-Source Forward Leakage	I_{GSS}	$V_{\text{GS}} = 20\text{V}$	—	—	100	nA
Gate-to-Source Reverse Leakage	I_{GSS}	$V_{\text{GS}} = -20\text{V}$	—	—	-100	nA
Total Gate Charge	Q_g	$I_D = 11\text{A}, V_{\text{DS}} = 200\text{V}, V_{\text{GS}} = 10\text{V}$, Note 4	—	—	63	nC
Gate-to-Source Charge	Q_{gs}		—	—	12	nC
Gate-to-Drain ("Miller") Charge	Q_{gd}		—	—	39	nC
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 125\text{V}, I_D = 11\text{A}, R_G = 9.1\Omega, R_D = 11\Omega$, Note 4	—	14	—	ns
Rise Time	t_r		—	49	—	ns
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$		—	42	—	ns
Fall Time	t_f		—	24	—	ns
Internal Drain Inductance	L_D	Between lead, .250in. (6.0) mm from package and center of die contact	—	5.0	—	nH
Internal Source Inductance	L_S		—	13	—	nH
Input Capacitance	C_{iss}	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 25\text{V}, f = 1\text{MHz}$	—	1400	—	pF
Output Capacitance	C_{oss}		—	320	—	pF
Reverse Transfer Capacitance	C_{rss}		—	73	—	pF

Source-Drain Ratings and Characteristics:

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Continuous Source Current (Body Diode)	I_S		—	—	15	A
Pulsed Source Current (Body Diode)	I_{SM}	Note 1	—	—	60	A
Diode Forward Voltage	V_{SD}	$T_J = +25^\circ\text{C}, I_S = 15\text{A}, V_{\text{GS}} = 0\text{V}$, Note 4	—	—	1.8	V
Reverse Recovery Time	t_{rr}	$T_J = +25^\circ\text{C}, I_F = 11\text{A}$, $dI/dt = 100\text{A}/\mu\text{s}$, Note 4	—	290	570	ns
Reverse Recovery Charge	Q_{rr}		—	3.1	6.3	μC
Forward Turn-On Time	t_{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S+L_D)				

Note 1. Repetitive rating; pulse width limited by maximum junction temperature.

Note 4. Pulse width $\leq 300\mu\text{s}$; duty cycle $\leq 2\%$.



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Note: Drain connected to metal part of mounting surface.